

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Takenori HIROKI</td> <td>09/11/2012</td> </tr> <tr> <td>Manabu EDAMURA</td> <td>09/11/2012</td> </tr> <tr> <td>Manabu SUGIURA</td> <td>09/11/2012</td> </tr> <tr> <td>Kouji ISHIKAWA</td> <td>09/11/2012</td> </tr> <tr> <td>Hidetoshi SATAKE</td> <td>09/11/2012</td> </tr> </tbody> </table>	Name	Execution Date	Takenori HIROKI	09/11/2012	Manabu EDAMURA	09/11/2012	Manabu SUGIURA	09/11/2012	Kouji ISHIKAWA	09/11/2012	Hidetoshi SATAKE	09/11/2012	
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RECEIVING PARTY DATA													
Name:	HITACHI CONSTRUCTION MACHINERY CO., LTD.												
Street Address:	5-1, Koraku 2-chome, Bunkyo-ku												
City:	Tokyo												
State/Country:	JAPAN												
Postal Code:	112-8563												
PROPERTY NUMBERS Total: 1													
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13698414</td> </tr> </tbody> </table>	Property Type	Number	Application Number:	13698414									
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Application Number:	13698414												
CORRESPONDENCE DATA													
Fax Number:	7036841157												
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>													
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NAME OF SUBMITTER:	John R. Mattingly												
Total Attachments: 1 source=8558-Assign#page1.tif													

OP \$40.00 13698414

ASSIGNMENT

(譲 渡 証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI CONSTRUCTION MACHINERY CO., LTD., a corporation organized under the laws of Japan, located at 5-1, Koraku 2-chome, Bunkyo-ku, Tokyo 112-8563 Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI CONSTRUCTION MACHINERY CO., LTD., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to
HYBRID CONSTRUCTION MACHINE

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI CONSTRUCTION MACHINERY CO., LTD., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI CONSTRUCTION MACHINERY CO., LTD.

Signed on the date(s) indicated aside our signatures:

INVENTOR(S)
(発明者フルネームサイン)

Date Signed
(署名日)

1) <u>Takenori Hiroki</u> Takenori HIROKI	<u>9/11/2012</u>
2) <u>Manabu Edamura</u> Manabu EDAMURA	<u>9/11/2012</u>
3) <u>Manabu Sagiura</u> Manabu SUGIURA	<u>9/11/2012</u>
4) <u>Kouji Ishikawa</u> Kouji ISHIKAWA	<u>9/11/2012</u>
5) <u>Hidetoshi Satake</u> Hidetoshi SATAKE	<u>9/11/2012</u>
6) _____	_____
7) _____	_____
8) _____	_____
9) _____	_____
10) _____	_____

PATENT